

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		25	V
V <sub>GS</sub>	Gate to Source Voltage		±20	V
ID	Drain Current -Continuous (Package Limited)		35	A
	-Continuous (Die Limited)		98	
	-Pulsed (N	ote 1)	305	
E <sub>AS</sub>	Single Pulse Avalanche Energy (N	ote 2)	91	mJ
PD	Power Dissipation		88	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 175	°C
Fhermal	Characteristics			
$R_{\theta JC}$	Thermal Resistance, Junction to Case TO_252, TO_251		1.7	°C/W

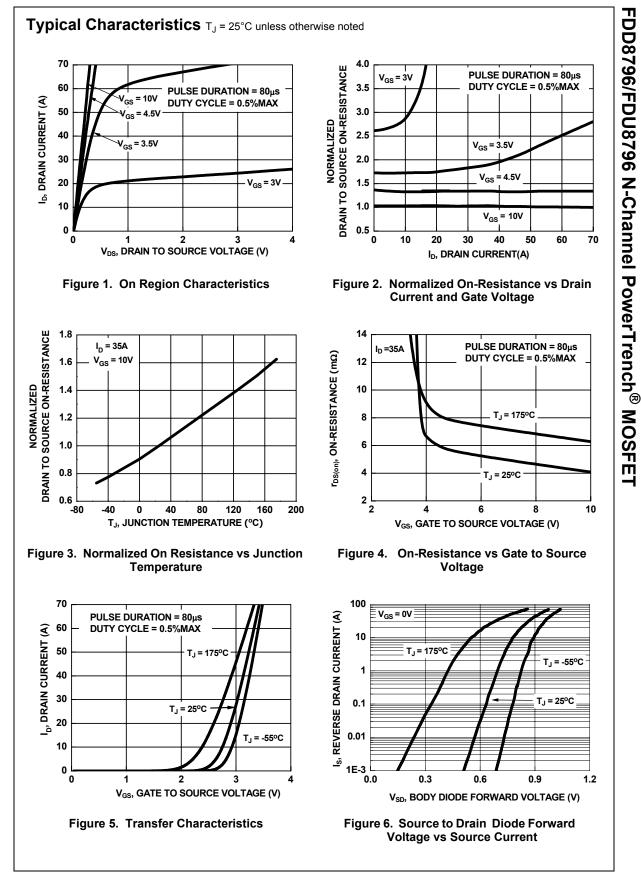
$R_{\thetaJC}$	Thermal Resistance, Junction to Case TO_252, TO_251	1.7	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient TO_252, TO_251	100	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient TO-252,1in <sup>2</sup> copper pad area	52	°C/W

# Package Marking and Ordering Information

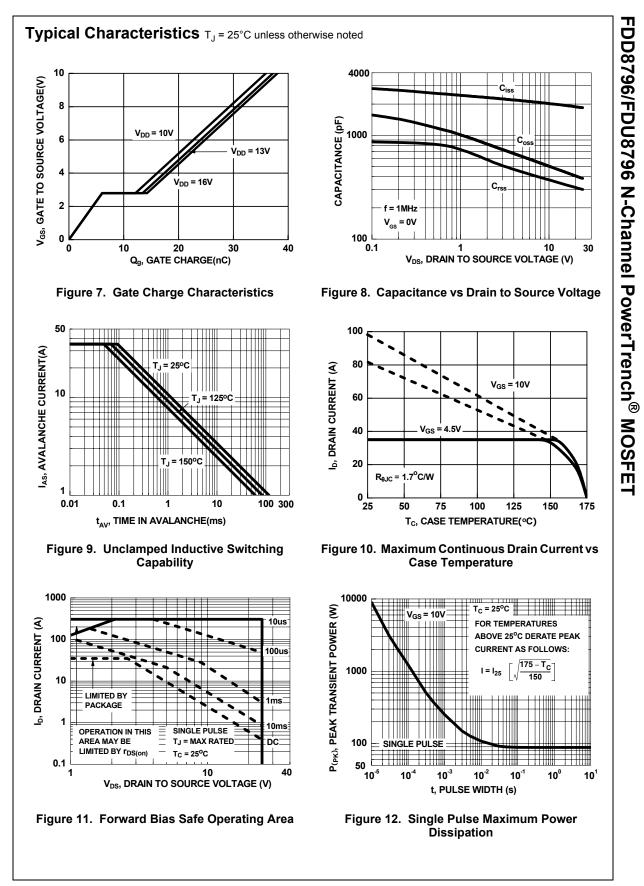
Device Marking	Device	ice Package Reel Size Tape Width		Quantity	
FDD8796	FDD8796	TO-252AA	13"	16mm	2500 units
FDU8796	FDU8796	TO-251AA	N/A (Tube)	N/A	75 units
FDU8796	FDU8796_F071	TO-251AA	N/A (Tube)	N/A	75 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	25			V
ΔB <sub>VDSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		7		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20V$ $V_{GS} = 0V$ $T_J = 150^{\circ}C$			1 250	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.2	1.8	2.5	V
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		-6.7		mV/°C
·		V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A		4.5	5.7	
r <sub>DS(on)</sub>	Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 35A		6.0	8.0	mΩ
		V <sub>DS</sub> = 10V, I <sub>D</sub> = 35A T <sub>J</sub> = 175°C		6.9 9.5		11122
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1960	2610	pF
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V, — f = 1MHz		455	605	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			315	475	pF
R <sub>G</sub>	Gate Resistance	f = 1MHz		1.1		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			10	20	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> =13V, I <sub>D</sub> = 35A		24	39	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_{GS} = 20\Omega$		99	158	ns
t <sub>f</sub>	Fall Time			57	91	ns
Qg	Total Gate Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{GS} = 0 \text{ to } 5V$ $V_{DD} = 13V,$ $I_{D} = 35A,$		37	52	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ to } 5V$ $V_{DD} = 13V,$		19	27	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 35A, I <sub>a</sub> = 1.0mA		6		nC
Q <sub>gd</sub>	Gate to Drain Charge			6		nC
Drain-Sou	urce Diode Characteristics	- · · · ·				
V	Source to Drain Diade Valtage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 35A		0.9	1.25	V
V <sub>SD</sub>	Source to Drain Diode Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 15A		0.8	1.0	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 35A, di/dt = 100A/μs		30	45	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 35A, di/dt = 100A/μs		23	35	nC

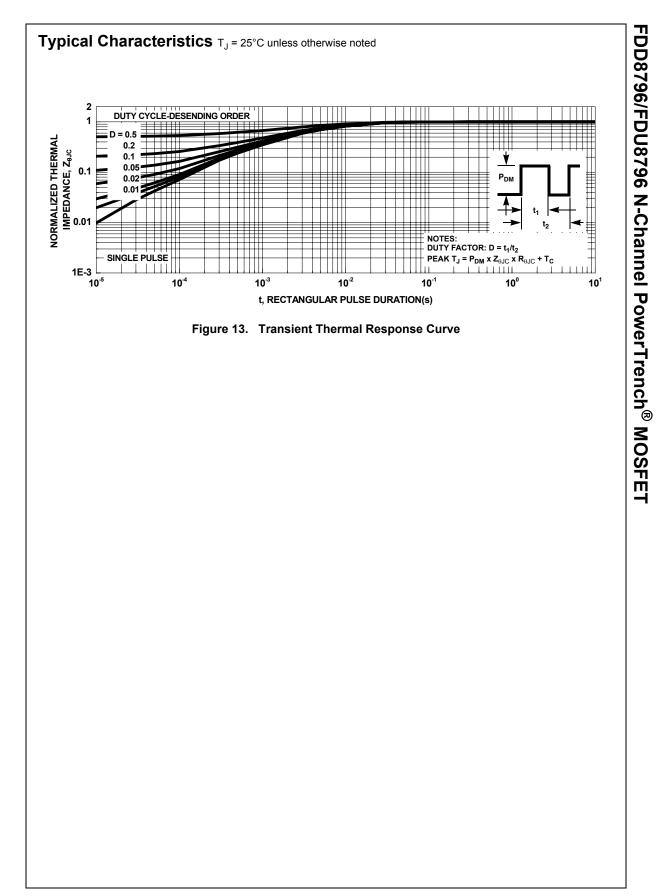
 $\label{eq:relation} \begin{array}{|c|c|c|} \hline $Q_{fT}$ & Reverse Recovery ordered \\ \hline $Notes:$ \\ 1: Pulse time < 300 \mu s, Duty cycle = 2%. \\ 2: Starting T_J = 25^\circ C, L = 0.3mH, I_{AS} = 24.7A, V_{DD} = 23V, V_{GS} = 10V. \\ \hline \end{tabular}$ 

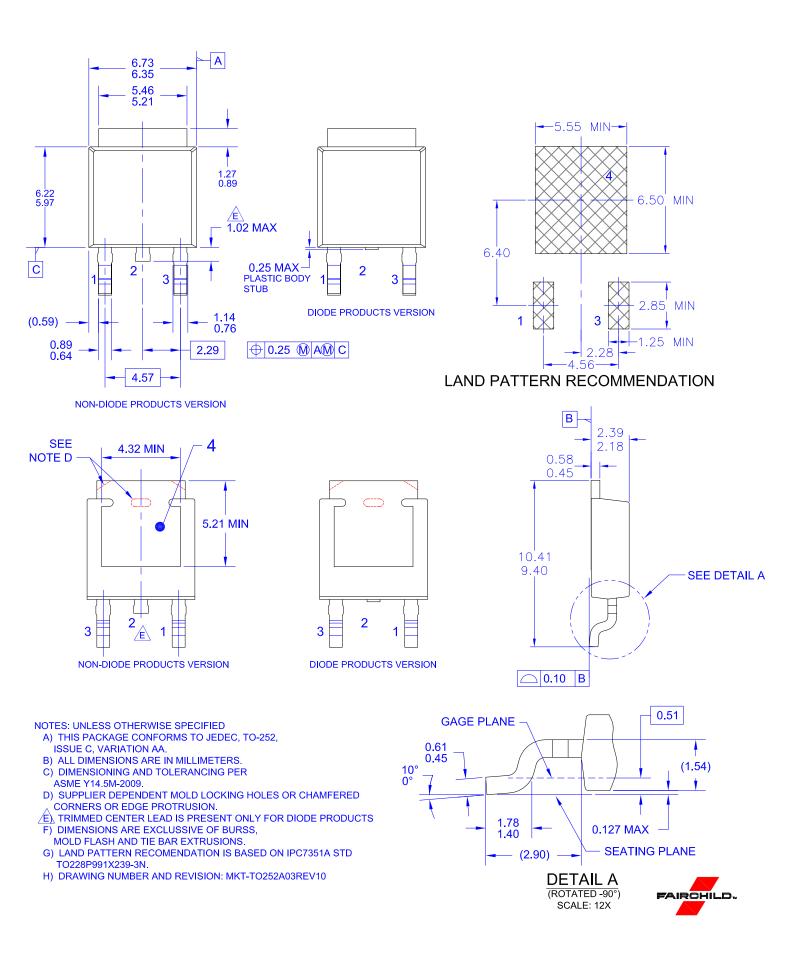


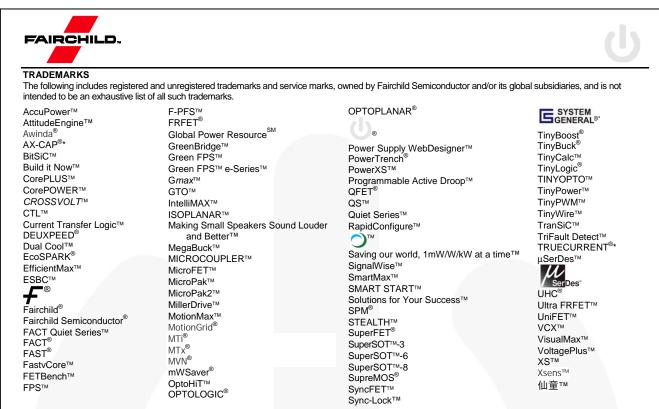
FDD8796/FDU8796 Rev. 1.1



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Rev. 175